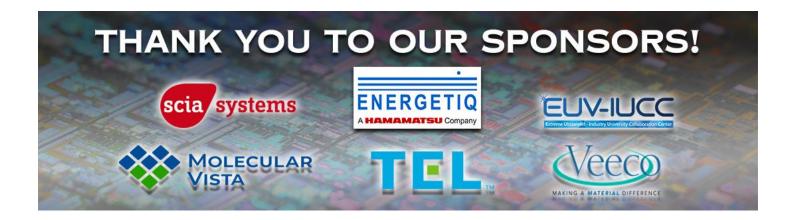


Workshop Proceedings



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Vivek Bakshi (EUV Litho, Inc), Chair Kurt Ronse (imec), Co-Chair

Group Photo



Workshop Proceedings 2023 EUVL Workshop & Supplier Showcase June 3rd - 7th, 2023 imec, Leuven, Belgium

2023 EUVL Workshop Day One: Monday, June 5th, 2023

2:00 PM - 2:10 PM Welcome and Announcements

2:10 PM Session One: imec EUVL Program Showcase

Chair: Kurt Ronse (imec)

Metrology for Scaling Towards 2030 (P74)

Philippe Leray imec

<u>Modeling Stochastic Effects in EUV Lithography with a Rigorous Physical Simulator (P75)</u>

Roel Gronheid KLA+

<u>High Repeatability and Low Shrinkage Solution Using CD-SEM For EUV</u> Resist (P73)

Masaki Sugie, Toshimasa Kameda, Shunsuke Mizutani *Hitachi HT*

EUV Stochastic Metrology with High Resolution and High Throughput E-Beam System (P72)

Abdalmohsen Elmalk ASML-HMI

<u>Patterning Control Solutions for EUV Challenges and Readiness Towards High</u> <u>NA EUV Transition (P71)</u>

Ran Alkoken *AMAT*



DAY ONE ADJOURNED 2023 EUVL Workshop

Day Two: Tuesday, June 6th, 2023

9:00 AM - 9:30 AM Welcome and Announcements

9:30 AM Session Two: Keynote Presentations

Chair: Kurt Ronse (imec)

The High-NA EUV Exposure Tool: Nearing Completion and Next Steps (P1)

Jan van Schoot

ASML

<u>Mask3D effects in EUV Lithography and Their Impact on Resolution</u> <u>Enhancements (P2)</u>

Andreas Erdman FhG IISB

BREAK 10:30 AM - 10:50 AM

10:50 AM Session Three: EUV Resist Patterning - 1

Co-Chairs: Alex Robinson (IM) and Sonia Castellanos (Inpria)

Gaining Insights Into EUV Radiation Chemistry (P33)

Patrick Naulleau *CXRO*

EUV Lithography Patterning Targeting Low Dose and High Resolution Using Multi-Trigger Resist (P35)

C. Popescu^a, G. O'Callaghan^a, A. McClelland^a, C. Storey^a, J. Roth^b, E. Jackson^b, A.P.G. Robinson^a, c

^aIrresistible Materials

^bNano-C

^cSchool of Chemical Engineering, University of Birmingham

EUV Lithography Patterning Towards Device Nano-Scaling (P39)

Danilo De Simone *imec*



High-NA Era: Interfaces Are the New Litho and Etch (P40)

Philippe Bezard imec

Metal Oxide Resist Formulation and Process Chemistry for High-NA EUV Lithography (P41)

Sonia Castellanos Inpria

<u>Dry Resist Patterning Progress and Readiness Towards High-NA EUV Lithography (P42)</u>

Anuja De Silva LAM

Challenges For Stochastic EUV Lithography Simulation (P43)

Ulrich Welling, Lawrence S. Melvin III, Hans-Jürgen Stock Synopsys GmbH

AM Session Adjourned

2:00 PM Session Three: Resist and Patterning – 2 Co-Chairs: Takeo Watanabe (University of Hyogo) and Seiji Nagahara (TEL)

Fundamental Research of EUV Resist Evaluation at NewSUBARU (P45)

Takeo Watanabe, Atsunori Nakamoto, Tetsuo Harada, Shinji Yamakawa *University of Hyogo*

<u>Advanced Resist Patterning Processes for High-NA EUV Lithography (P44)</u>

Seiji Nagahara TEL

LWR Offset: Identifying Root Causes by Simulation (P31)

Luc van Kessel, Bernardo Oyarzun, Joost van Bree, Ruben Maas *ASML*

<u>Organic-Inorganic Hybrid EUV Photoresists Derived From Atomic Layer</u> <u>Deposition (P32)</u>

Chang-Yong Nam¹, Jiyoung Kim²
¹Center for Functional Nanomaterials, Brookhaven National Laboratory
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²Department of Materials Science and Engineering, University of Texas at Dallas

Disruptive EUV Material Characterization in imec's AttoLab (P36)

Kevin Dorney

imec

<u>Development of Computational Spectroscopies to Unravel Atomistic Mechanism in EUVL (P37)</u>

Michiel van Setten imec

DSA-Assisted EUV Patterning (P38)

Hyo Seon Suh, Lander Verstraete, Julie Van Bel, Purnota Hannan Timi, Remi Vallat, Philippe Bezard, Jelle Vandereyken, Matteo Beggiato, A.m.ir-Hossein Ta.m.addon, Christophe Beral, Waikin Li, Mihir Gupta, Roberto Fallica

BREAK 3:45 PM - 4:05 PM

4:05 PM Session Four: EUV Sources

Co-Chairs: David Reisman (Energetiq) and Yusuke Teramoto (Ushio)

<u>Plasma Dynamics and Future of LPP-EUV Source for Semiconductor</u> <u>Manufacturing (P53)</u>

Hakaru Mizoguchi, ³Kentaro Tomita, ⁴Yiming Pan, ⁵Atsushi Sunahara, ²Kouichiro Kouge, ⁶Katsunobu Nishihara, ¹Daisuke Nakamura, ¹Yukihiro Yamagata, and ¹Masaharu Shiratani

Gigaphoton

- 1. Quantum and Photonics Technology Research Center, Graduate School of Information and Electrical Engineering, Kyushu University
- 2. Gigaphoton Inc.
- 3. Division of Quantum Science and Engineering, Graduate School of Engineering, Hokkaido University
- 4. Interdisciplinary Graduate School of Engineering Sciences, Kyushu University
- 5. Center for Materials Under eXtreme Environment (CMUXE), School of Nuclear Engineering, Purdue University
- 6. Institute of Laser Engineering, Osaka University

<u>High-Brightness EUV Source For Inspection and Exposure Applications (P55)</u>

Yusuke Teramoto¹, Kazuya Aoki², Akihisa Nagano², Noritaka Ashizawa², Takahiro Shirai², Shunichi Morimoto², Hidenori Watanabe², Yoshihiko Sato²

- ¹ Ushio Germany GmbH
- ² Ushio Inc.



Source Driven By A Solid-State Pulsed-Power System (P52)

David Reisman¹, Daniel Arcaro¹, Wolfram Neff¹, Michael Roderick¹, Bob Grzybinski¹, Scott Moore¹, Chris Lee¹, and Fred Niell²

¹ Energetiq Technology, Inc.

BREAK 4:50 PM - 5:10 PM

5:10 PM Session Five: Poster Session and Reception Session Co-Chairs: Vivek Bakshi (EUV Litho, Inc.) and Kurt Ronse (imec)

<u>Investigating the Impact of Multi-Emission Layers on the Emissivity of EUV Pellicles (P20)</u>

Young Woo Kang, Seong Ju Wi, Ha Neul Kim, Won Jin Kim, Jungyeon Kim and Jinho Ahn Hanyang University, EUV-IUCC (Industry University Collaboration Center)

EUV Lighting Technique By the Irradiation of C-Beam. and Its Characteristics (P54)

Bishwa Chandra Adhikari, Kyu Chang Park
Department of Information Display, Kyung Hee University

<u>Deposition, Etching and Cleaning for EUVL Optics with UHV Processing Equipment (P79)</u>

Marcel Demmler Scia Systems

<u>Performance of a DPP EUV Source Drive By a Solid-State Pulsed-Power System (P80)</u>

David Reisman Energetia

<u>Advanced Lab-Scale Spectro-Microscopies for Characterization and Enhancement of EUV Materials (P46)</u>

Kevin M. Dorney^{1,*}, Nicola N. Kissoon², Fabian Holzmeier¹, Esben W. Larsen¹, Dhirendra P. Singh¹, Claudia Fleischmann^{1,2}, Stefan De Gendt^{1,3}, Paul A.W. van der Heide¹, John S. Petersen¹

¹imec vzw

²Quantum Solid State Physics, KU Leuven

³ Chemistry Department, KU Leuven





² Nielltronix Inc.

EUV Reflectometry and Ptychography for the Characterization of Thin Films, Stacks, Photoresists, and In-Depth Imaging of Nano-sized Structures (P47)

K.M. Dorney¹, N.N. Kissoon², E. W. Larsen¹, F. Holzmeier¹, I.A. Makhotkin³, V. Philipsen¹, J.S. Petersen¹, S. De Gendt^{1,2}, V.V. Krasnov^{*,1,2}, P. van der Heide¹, C. Fleischmann^{1,2}

¹ imec

Mean Free Path of Electrons in EUV Photoresists in the Range 20-450 eV (P48)

Roberto Fallica

imec

<u>CHiPPS EFRC at ALS: EUV Photoresist Funda.m.entals and Soft X-ray Metrology</u> (P49)

Cheng Wang Lawrence Berkeley National Lab

Reflective Optics at Thales SESO: Opportunities for EUV Lithography (P83)

Dr. Luca Peverini Thales SESO SAS

Near-field Infrared Nanoscopic Study of EUV- and e-beam-exposed Hydrogen Silsesquioxane Photoresist (P50)

Jiho Kim¹, Jin-Kyun Lee³, Boknam Chae¹, Jinho Ahn⁴, Sangsul Lee¹

¹Pohang Accelerator Laboratory, POSTECH

Intrafield overlay and reproducibility on thin resist towards High NA (P91)

Christiane Jehoula, Jan Hermansa, Anne-Laure Charleya, Rishab Baganib, Gabriel Zaccab, Maurits van der Schaarb imec

DAY TWO ADJOURNED



² KU Leuven

³Industrial Focus Group XUV Optics, MESA+ Institute for Nanotechnology, University of Twente

²Department of Semiconductor Engineering, POSTECH

³Department of Polymer Science and Engineering, Inha University

⁴Division of Materials Sceince and Engineering, Hanyang University

2023 EUVL Workshop Day Three: Wednesday, June 7th, 2023

9:00 AM - 9:10 AM Welcome and Announcements

9:10 AM Session Six: EUV Masks

Co-Chairs: Jinho Ahn (Hanyang University) and Katrina Rook

(Veeco)

Metal Silicide EUV Pellicle and the Effect of Wrinkles On Mask3D Effects (P13)

Dong Gi Lee,^{a,c} Seungchan Moon,^{b,c} Jinhyuk Choi, ^{b,c} Seung Ju Wi ^{a,c} and Jinho Ahn,^{a,b,c,*}

^aDivision of Materials Science and Engineering, Hanyang University

^bDivision of Nanoscale Semiconductor Engineering, Hanyang University

cEUV-IUCC (Industry University Collaboration Center), Hanyang University

Masks For Optimized Imaging with High-NA EUV Lithography (P11)

M.-Claire van Lare, Eelco van Setten, Jo Finders *ASML Netherlands B.V.*

Developing Cost-Effective Actinic Solutions for EUV Lithography (P12)

Dong Gun Lee and Byung Gook Kim ESOL (EUV Solution), Inc.

High-K Based Near n≈1 EUV Mask for M3D Effects and Focus Control in High-NA Lithography (P14)

Dongmin Jeong, Yunsoo Kim, Seung Ho Lee, and Jinho Ahn Hanyang University, EUV-IUCC (Industry University Collaboration Center)

CNT Pellicles: Recent Optimization and Exposure Results (P15)

J. Bekaert, E. Gallagher, M. Y. Timmermans, I. Pollentier, R. Jonckheere, R. Aubert, E. Hendrickx



imec

Mask Challenges Towards High-NA EUV Lithography (P16)

Andreas Frommold imec

Metrology and Inspection for High-NA EUV Lithography (P17)

Roel Gronheid KLA+

<u>Probing the Layer and Interlayer Quality of Mo/Si and Ru/Si Multilayers for EUV Mask Blanks (P19)</u>

Katrina Rook Veeco

BREAK 11:10 AM - 11:30 AM

11:30 AM Session Seven: EUV Supplier Showcase

Co-Chairs: Meng Lee (Veeco) and Ibrahim Burki (Hoya)

Industrialization of EUVL and Future Roadmap (P62)

Raymond Maas ASML

<u>Accelerating the Journey to Future Technology Nodes with Veeco's Advanced Technologies in Deposition and Etch (P70)</u>

Meng Lee Veeco

<u>High-NA EUV Mask Blank Development with Smart Factory (I4.0) Advanced</u> <u>Analytics and AI Process Control (P61)</u>

Ibrahim Burki, Zaw Win Phyo *Hova*

An Overview of EUVL Activities at Berkeley Lab (P64)

Patrick Naulleau *CXRO-LBL*

AM SESSION ADJOURNED



2:00 PM Session Eight: EUV Supplier Showcase Co-Chairs: Jochen Vieker (Fraunhofer) and Patrick Naulleau (EUV Tech)

<u>Irradiation System for Testing of EUVL Components – Status of Incorporation (P67)</u>

Jochen Vieker

Fraunhofer Institute for Laser Technology - ILT

<u>Design Approaches for High-Flux High-Harmonic Generation Sources Using Advanced</u> <u>Nonlinear Laser Technologies (P63)</u>

Robert Riedel

Class 5 Photonics GmbH

<u>Providing Powerful and Stabile Extreme Ultraviolet (EUV) Light to Support the EUV Lithography Metrology Ecosystem (P66)</u>

Henry Chou Energetiq Technology

Extreme Cleanliness by Dry UHV Processing (P76)

Marcel Demmler scia Systems GmbH

Synchrotron-Radiation Based EUV Metrology at PTB (P69)

Michael Kolbe, Christian Laubis, Richard Ciesielski, Victor Soltwisch, Andreas Fischer, Frank Scholze

Physikalisch-Technische Bundesanstalt (PTB)

Nanoscale Chemical Analysis of EUV Resists (P68)

Derek Nowak, Tom Albrecht, Sung Park Molecular Vista

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An Introduction to EUV Tech (P81)

Patrick Naulleau *EUV Tech*

<u>Extreme-Ultraviolet Metrology at the Synchrotron Ultraviolet Radiation Facility</u> (P82)

Edward Hagley, C. Tarrio, R. F. Berg, R. E. Vest, and S. Grantham. *National Institute of Standards and Technology (NIST)*

BREAK 3:45 PM - 4:05 PM

4:05 PM Session Nine: Optics and Metrology

Co-Chairs: Gian Lorusso (imec) and Iacopo Mochi (PSI)

High-NA EUV Optics: Preparing the Next Major Lithography Step (P21)

Alexandre Lopes, Paul Graeupner, Peter Kuerz Carl Zeiss SMT GmbH

Transparent Conductive Backside Coatings for EUV Mask Tuning (P23)

Klara Stallhofer¹, Philipp Naujok¹, Torsten Feigl¹, Chen Klein², Alastair Cunningham², Valerio Pruneri²

¹optiX fab Gmb

²ICFO-Institut de Ciencies Fotoniques, The Barcelona Institute of Science and Technology

Grazing Incidence Wafer Metrology with REGINE (P18)

Iacopo Mochi, Tao Shen, Paolo Ansuinelli, Yasin Ekinci Paul Scherrer Institute

Trends in E-Beam Metrology and Inspection (P22)

Gian Francesco Lorusso imec

Optical Materials Constants in the EUV and Their Impact on Scatterometry Measurements (P24)

Richard Ciesielski

Physikalisch-Technische Bundesanstalt (PTB)

<u>EUV Spectrometry as a Versatile Characterization Technique for Thin Film Layer Systems (P25)</u>



Sascha Brose^{1,2}, Sophia Schröder^{1,2}, Sven Glabisch^{1,2}, Jochen Stollenwerk^{1,2,3}, and Carlo Holly^{1,2,3}

¹RWTH Aachen University TOS - Chair for Technology of Optical Systems ²JARA - Fundamentals of Future Information Technology, Research Centre Jülich ³Fraunhofer ILT - Institute for Laser Technology

5:50 PM - 6:00 PM Announcements

2023 EUVL Workshop & Supplier Showcase Adjourned



